

# DSC5G03

## Silicon NPN epitaxial planar type

For high-frequency amplification  
DSC2G03 in SMini3 type package

### ■ Features

- High transition frequency  $f_T$
- Halogen-free / RoHS compliant  
(EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

### ■ Marking Symbol: C6

### ■ Packaging

DSC5G03×0L Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	30	V
Collector-emitter voltage (Base open)	$V_{CEO}$	20	V
Emitter-base voltage (Collector open)	$V_{EBO}$	3	V
Collector current	$I_C$	50	mA
Collector power dissipation	$P_C$	150	mW
Junction temperature	$T_j$	150	$^\circ\text{C}$
Operating ambient temperature	$T_{opr}$	-40 to +85	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

### ■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	$I_C = 100 \mu\text{A}, I_E = 0$	30			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 10 \mu\text{A}, I_C = 0$	3			V
Base-emitter voltage	$V_{BE}$	$V_{CE} = 10 \text{V}, I_C = 2 \text{mA}$		740		mV
Forward current transfer ratio	$h_{FE}$	$V_{CE} = 10 \text{V}, I_C = 2 \text{mA}$	25		250	—
Transition frequency <sup>*1,2</sup>	$f_T$	$V_{CE} = 10 \text{V}, I_C = 15 \text{mA}$	800		1 600	MHz
Reverse transfer capacitance (Common emitter)	$C_{re}$	$V_{CE} = 10 \text{V}, I_C = 1 \text{mA}, f = 10.7 \text{MHz}$		0.9		pF
Reverse transfer capacitance (Common base)	$C_{rb}$	$V_{CB} = 6 \text{V}, I_C = 0, f = 1 \text{MHz}$		0.7		pF
Power gain	PG	$V_{CE} = 10 \text{V}, I_C = 1 \text{mA}, f = 200 \text{MHz}$		20		dB

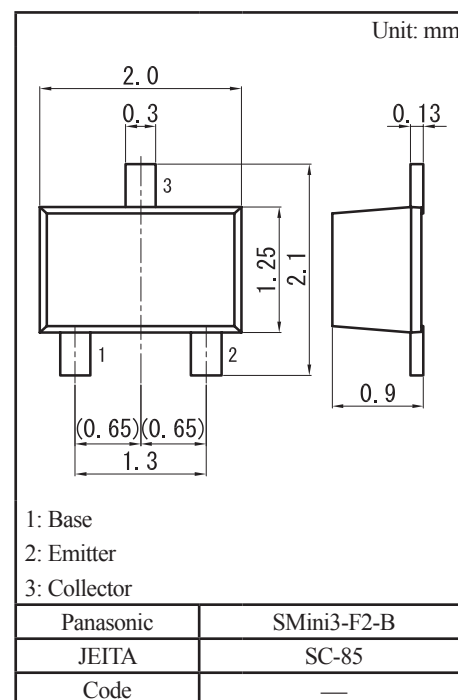
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

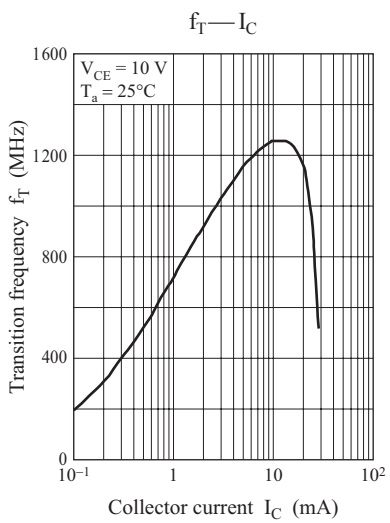
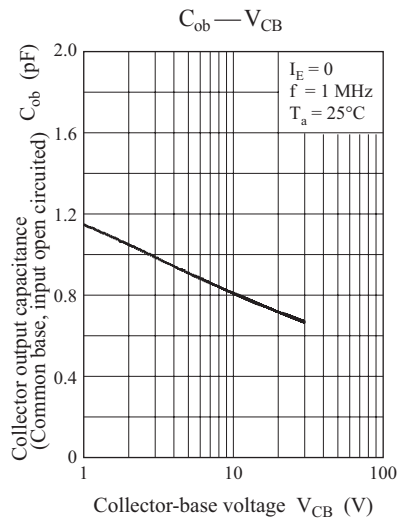
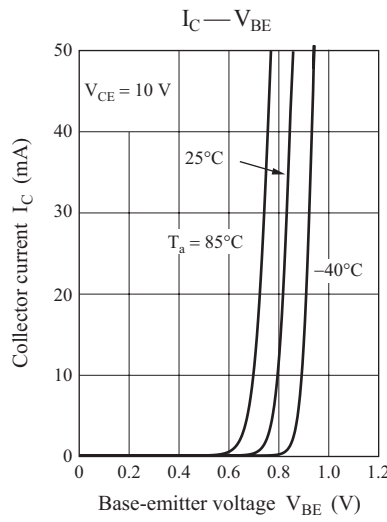
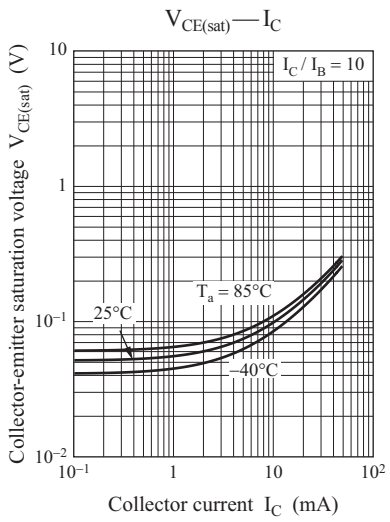
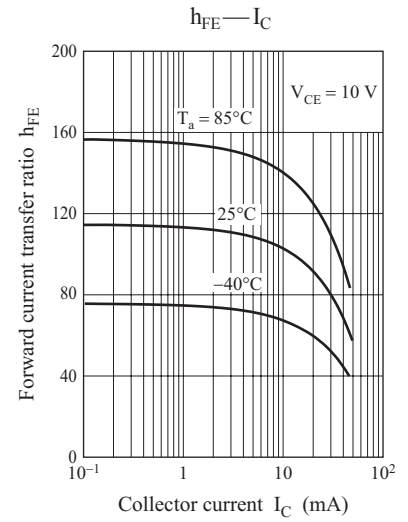
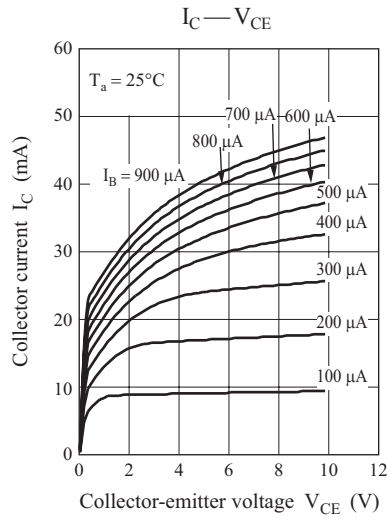
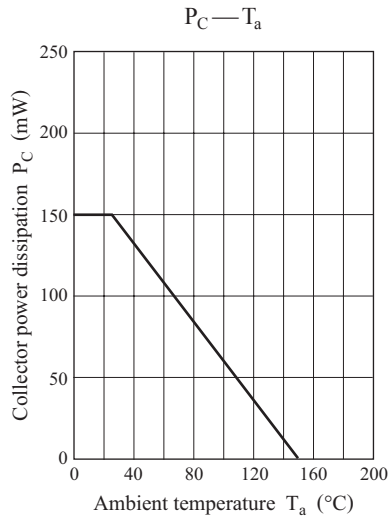
2. \*1: Pulse measurement

\*2: Rank classification

Code	T	S	0
Rank	T	S	No-rank
$f_T$	800 to 1 400	1 400 to 1 600	800 to 1 600
Marking Symbol	C6T	C6S	C6

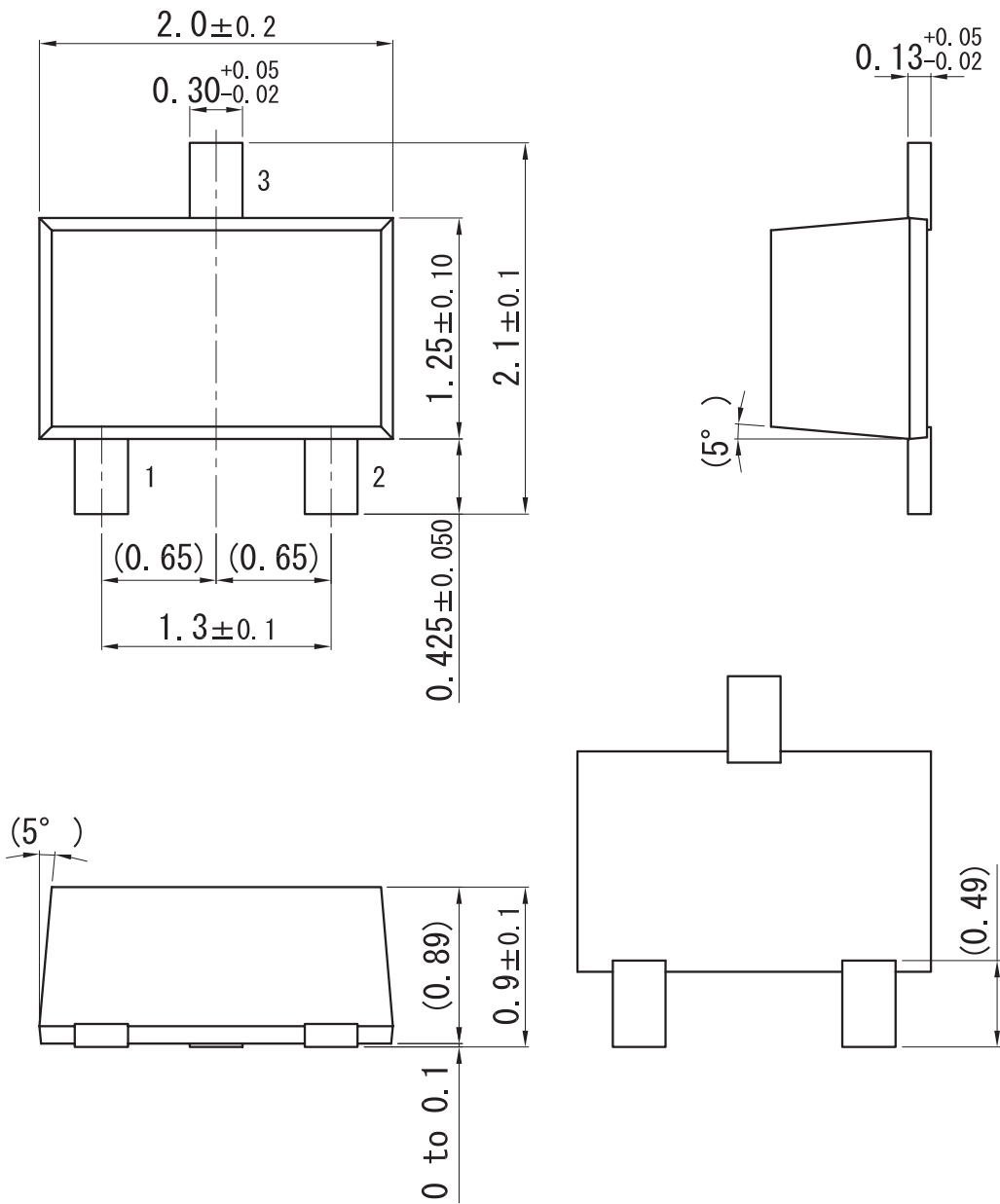
Product of no-rank is not classified and have no marking symbol for rank.



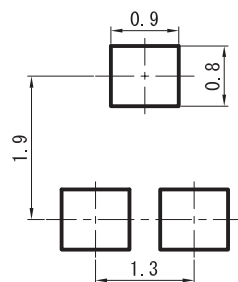


SMini3-F2-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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